Rev. 1-10-03 Effective March 1998

## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

() Original () Supplemental () Substitute (X) PCT () DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## Title: NEGATIVE RESIST COMPOSITION AND METHOD OF FORMING RESIST PATTERN

of which	ic do	caribad	and	alaimad	in.
or which	is ae	scribea	and	ciaimed	ı ın:

- () the attached specification, or
- () the specification in application Serial No. NEW, filed September 23, 2005, and with amendments through \_
- (X) the specification in International Application No. PCT/JP2004/004080, filed March 24, 2004, and as amended on (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
JP	2003-92767	March 28, 2003	Yes
JP	2004-051608	February 26, 2004	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Huppert, Reg. No. 40,268; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from Sakai International Patent Office as

to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to: Direct Telephone Calls to: WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 CUSTOMER NO. Washington, D.C. 20006-1021 000513 Phone:(202) 721-8200 Fax:(202) 721-8250 FIRST GIVEN NAME FAMILY NAME SECOND GIVEN NAME Full Name of **IWASHITA** Jyun First Inventor STATE OR COUNTRY COUNTRY OF CITIZENSHIP Residence & Kanagawa Japan Japan Citizenship ADDRESS CITY STATE OR COUNTRY ZIP CODE **Post Office** c/o TOKYO OHKA KOGYO CO., LTD. Address 150 Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan FIRST GIVEN NAME FAMILY NAME SECOND GIVEN NAME Full Name of **TACHIKAWA** Toshikazu **Second Inventor** STATE OR COUNTRY COUNTRY OF CITIZENSHIP Residence & Kanagawa Japan Citizenship Japan ADDRESS CITY STATE OR COUNTRY ZIP CODE Post Office c/o TOKYO OHKA KOGYO CO., LTD. Address 150 Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor	Date
Jyun IWASHITA	
2nd Inventor	Date
Toshikazu TACHIKAWA	

The above application may be more particularly identified as follows:

U.S. Application Serial No. NEW Filing Date September 23, 2005

Applicant Reference Number <u>PTKA-040340US(AN-004/PCT)</u> Atty Docket No. <u>01796/PTKA-040340US(AN-004/PCT)</u> 2005 <u>1513A</u>

Title of Invention NEGATIVE RESIST COMPOSITION AND METHOD OF FORMING RESIST PATTERN